



UT4435

Power MOSFET

-8.8A, -30V P-CHANNEL POWER MOSFET

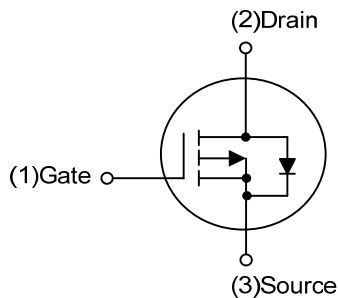
■ **DESCRIPTION**

The **UT4435** uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with low gate voltages. This device is suitable for use as a load switch or in PWM applications.

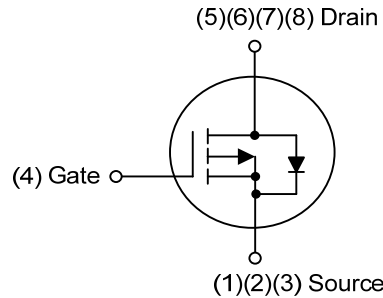
■ **FEATURES**

- * $R_{DS(ON)} \leq 20\text{ m}\Omega$ @ $V_{GS} = -10\text{V}$, $I_D = -8.8\text{A}$
- * $R_{DS(ON)} \leq 35\text{ m}\Omega$ @ $V_{GS} = -4.5\text{V}$, $I_D = -6.7\text{A}$
- * Low capacitance
- * Low gate charge
- * Fast switching capability
- * Avalanche energy specified

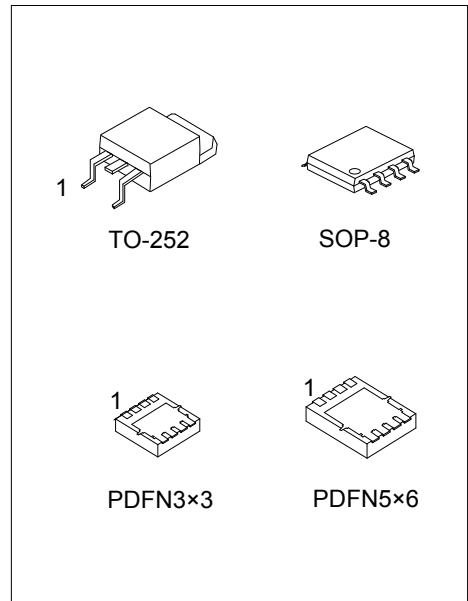
■ **SYMBOL**



TO-252



SOP-8/PDFN3x3/PDFN5x6



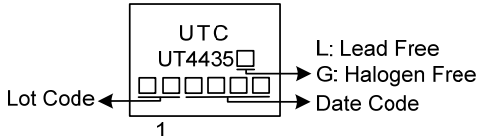
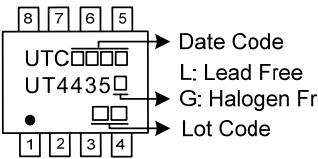
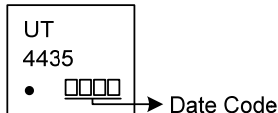
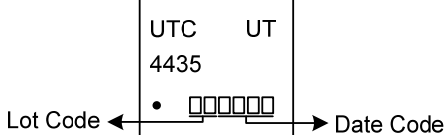
■ **ORDERING INFORMATION**

Ordering Number		Package	Pin Assignment								Packing
Lead Free	Halogen Free		1	2	3	4	5	6	7	8	
UT4435L-TN3-R	UT4435G-TN3-R	TO-252	G	D	S	-	-	-	-	-	Tape Reel
UT4435L-S08-R	UT4435G-S08-R	SOP-8	S	S	S	G	D	D	D	D	Tape Reel
UT4435L-P3030-R	UT4435G-P3030-R	PDFN3x3	S	S	S	G	D	D	D	D	Tape Reel
UT4435L-P5060-R	UT4435G-P5060-R	PDFN5x6	S	S	S	G	D	D	D	D	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source

<p>UT4435G-TN3-R</p> <p>(1)Packing Type</p> <p>(2)Package Type</p> <p>(3)Green Package</p>	<p>(1) R: Tape Reel</p> <p>(2) TN3: TO-252, S08: SOP-8, P3030: PDFN3x3 P5060: PDFN5x6</p> <p>(3) G: Halogen Free and Lead Free, L: Lead Free</p>
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■ MARKING

TO-252	SOP-8
 <p>UTC UT4435 □ □ □ □ □ □ □ 1</p> <p>Lot Code ←</p> <p>→ L: Lead Free → G: Halogen Free → Date Code</p>	 <p>8 7 6 5 UTC □ □ □ □ UT4435 □ • □ □ 1 2 3 4</p> <p>→ Date Code → L: Lead Free → G: Halogen Free → Lot Code</p>
PDFN3×3	PDFN5×6
 <p>UT 4435 • □ □ □</p> <p>→ Date Code</p>	 <p>UTC UT 4435 • □ □ □ □ □</p> <p>Lot Code ← → Date Code</p>

■ ABSOLUTE MAXIMUM RATINGS (T_A=25°C, unless otherwise specified)

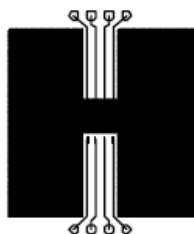
PARAMETER	SYMBOL	RATINGS	UNIT
Drain-Source Voltage	V _{DSS}	-30	V
Gate-Source Voltage	V _{GSS}	±25	V
Continuous Drain Current (Note 3a)	I _D	-8.8	A
Pulsed Drain Current	I _{DM}	-50	A
Power Dissipation (Note 3b)	TO-252	1.25	W
	SOP-8	1	W
	PDFN3×3	1.13	W
	PDFN5×6	1.56	W
Junction Temperature	T _J	+150	°C
Storage Temperature	T _{STG}	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

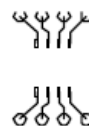
Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Pulse Test: Pulse Width < 300μs, Duty Cycle < 2.0%.

3. θ_{JA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. θ_{JC} is guaranteed by design while θ_{JA} is determined by the user's board design.



a) 50°C/W when mounted on a 1 in² pad of 2 oz copper



b) 125°C/W when mounted on a minimum pad.

■ THERMAL CHARACTERISTICS

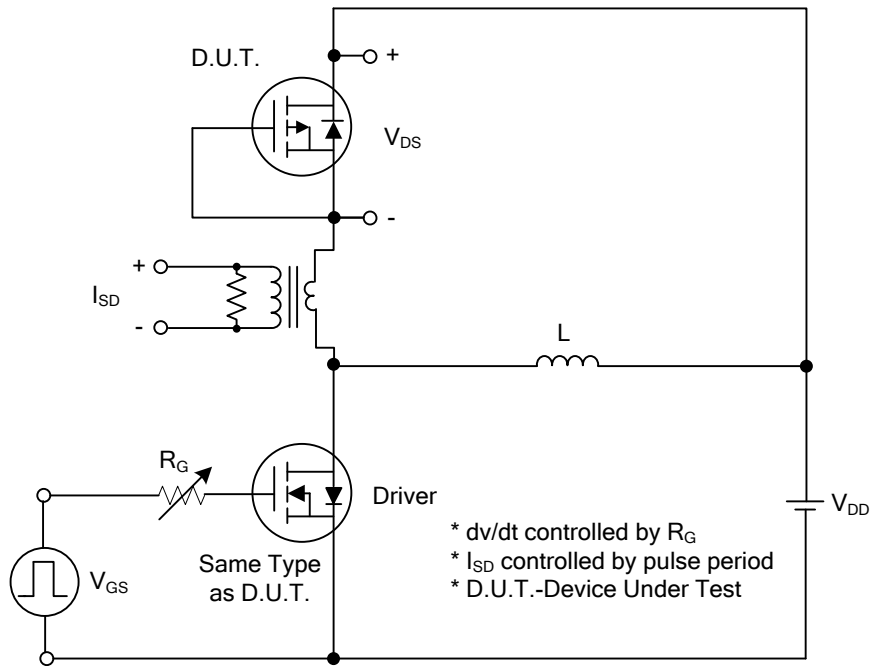
PARAMETER	SYMBOL	RATINGS	UNIT
Junction to Ambient (Note 3a)	TO-252	40	°C/W
	SOP-8	50	°C/W
	PDFN3×3	45	°C/W
	PDFN5×6	42.5	°C/W
Junction to Ambient(Note 3b)	TO-252	100	°C/W
	SOP-8	125	°C/W
	PDFN3×3	110	°C/W
	PDFN5×6	80	°C/W
Junction to Case	TO-252	2.78	°C/W
	SOP-8	25	°C/W
	PDFN3×3	13	°C/W
	PDFN5×6	3.5	°C/W

■ ELECTRICAL CHARACTERISTICS (T_A=25°C, unless otherwise specified)

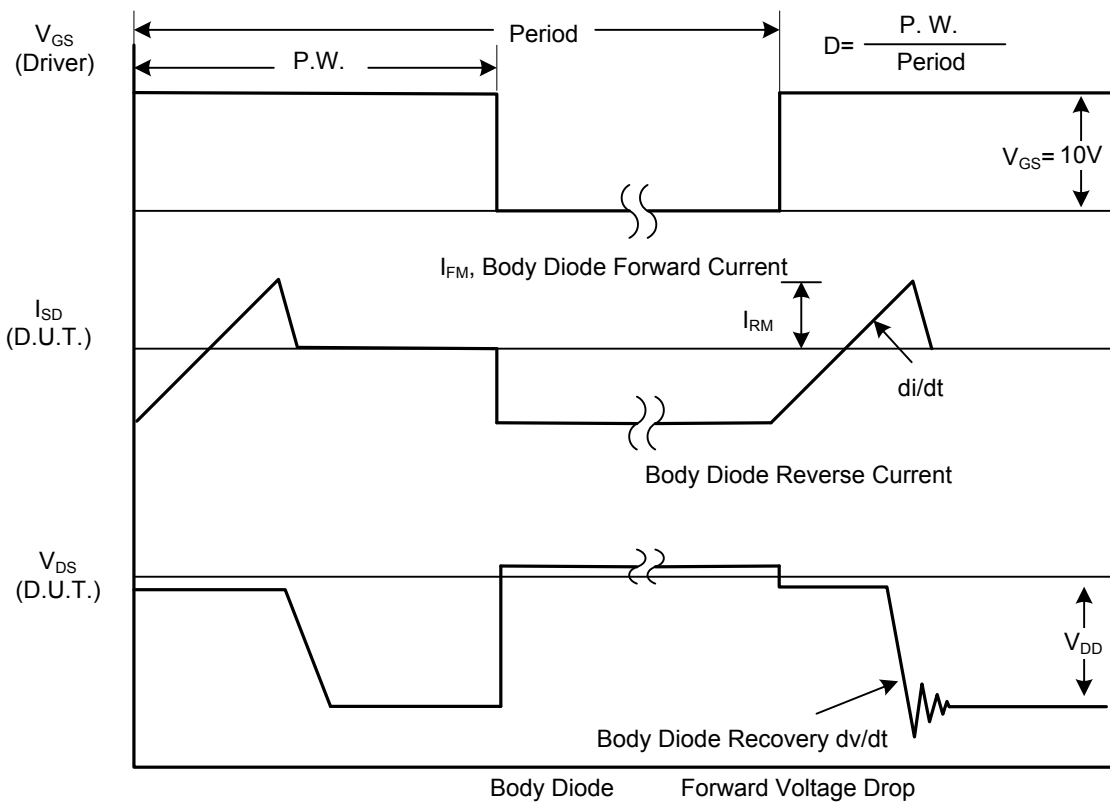
PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =-250μA	-30			V
Drain-Source Leakage Current	I _{DSS}	V _{DS} =-24 V, V _{GS} =0V			-1	μA
Gate-Source Leakage Current	I _{GSS}	V _{GS} =±25 V, V _{DS} =0V			±100	nA
ON CHARACTERISTICS(Note)						
Gate-Threshold Voltage	V _{GS(TH)}	V _{DS} =V _{GS} , I _{DS} =-250μA	-1.0	-1.7	-3.0	V
On State Drain Current	I _{D(ON)}	V _{GS} =-10V, V _{DS} =-5V	-50			A
Static Drain-Source On-Resistance	R _{DS(ON)}	V _{GS} =-10V, I _D =-8.8A		16.5	20	mΩ
		V _{GS} =-4.5V, I _D =-6.7A		26	35	mΩ
Forward Transconductance	g _{FS}	V _{DS} =-5V, I _D =-8.8A		24		S
DYNAMIC PARAMETERS						
Input Capacitance	C _{ISS}	V _{DS} =-15V, V _{GS} =0V, f=1.0MHz		1750		pF
Output Capacitance	C _{OSS}			305		pF
Reverse Transfer Capacitance	C _{RSS}			250		pF
SWITCHING PARAMETERS(Note)						
Total Gate Charge	Q _G	V _{DS} =-15V, V _{GS} =-10V, I _D =-8.8A		38		nC
Gate-Source Charge	Q _{GS}			5		nC
Gate-Drain Charge	Q _{GD}			9		nC
Turn-ON Delay Time	t _{D(ON)}	V _{DD} =-15V, V _{GS} =-10V, I _D =-8.8A R _G =6Ω		11		ns
Turn-ON Rise Time	t _R			23		ns
Turn-OFF Delay Time	t _{D(OFF)}			47		ns
Turn-OFF Fall-Time	t _F			38		ns
DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS						
Maximum Body-Diode Continuous Current	I _S				-2.1	A
Diode Forward Voltage(Note)	V _{SD}	I _S =-2.1A, V _{GS} =0V			1.4	V

Note: Pulse Test: Pulse Width < 300μs, Duty Cycle < 2.0%.

■ TEST CIRCUITS AND WAVEFORMS

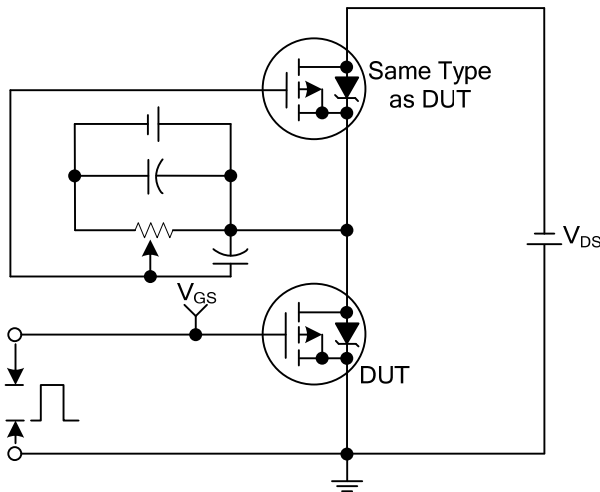


Peak Diode Recovery dv/dt Test Circuit

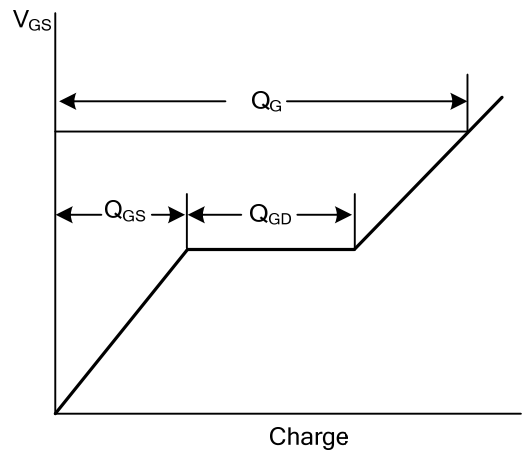


Peak Diode Recovery dv/dt Waveforms

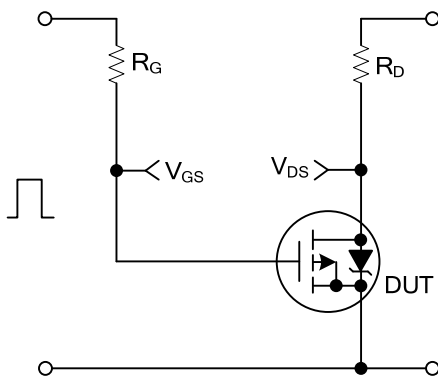
■ TEST CIRCUITS AND WAVEFORMS



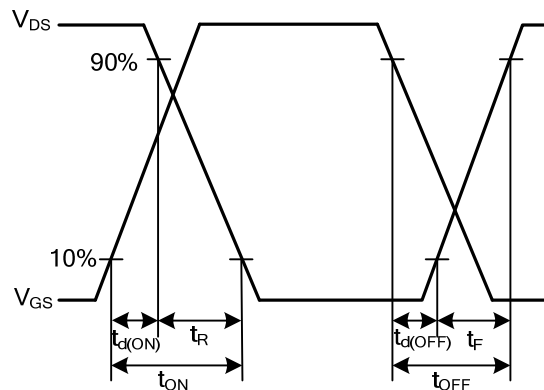
Gate Charge Test Circuit



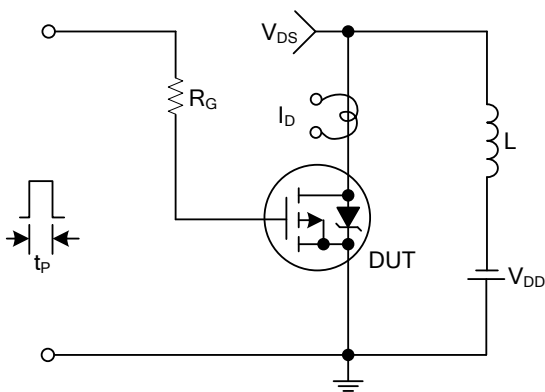
Gate Charge Waveforms



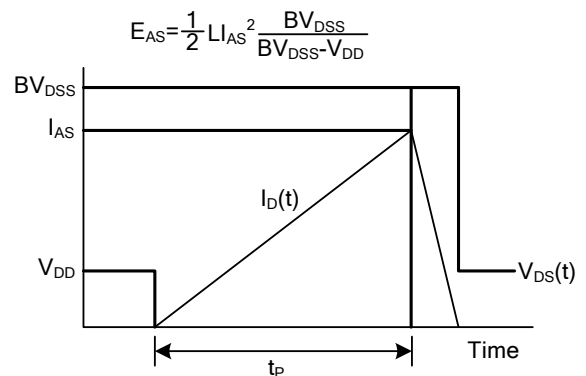
Resistive Switching Test Circuit



Resistive Switching Waveforms

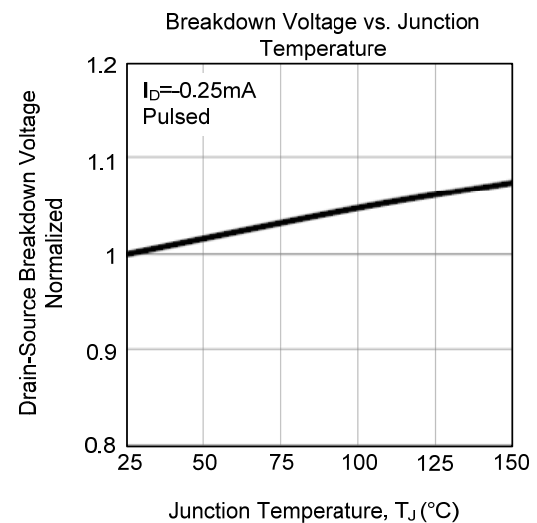
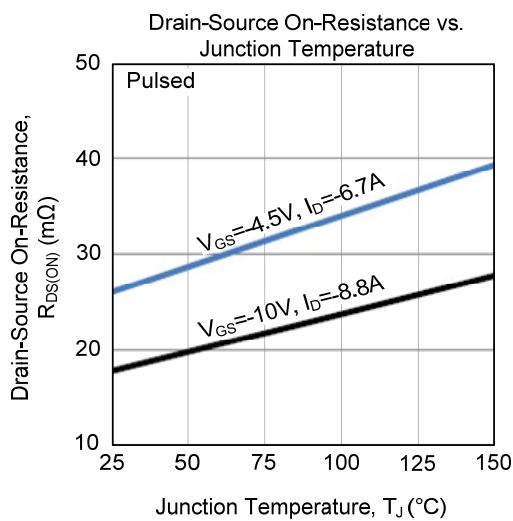
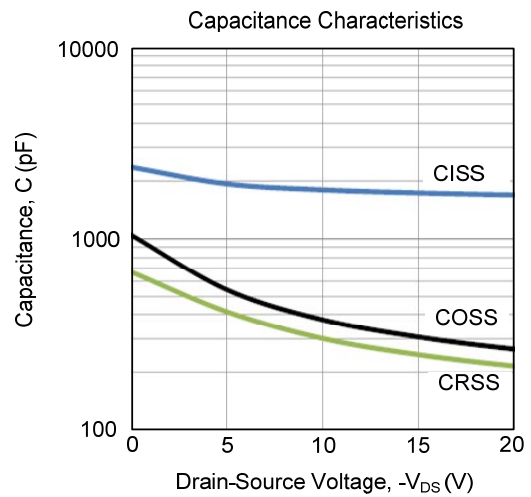
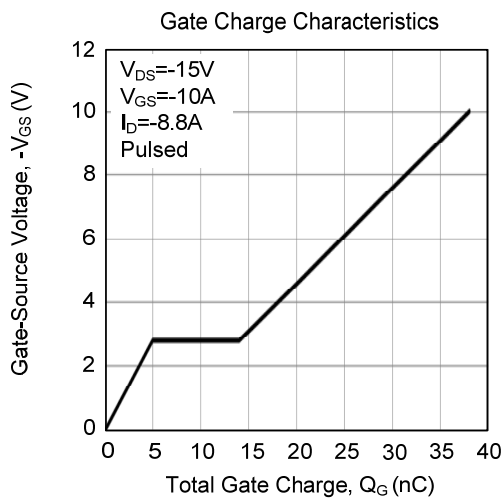
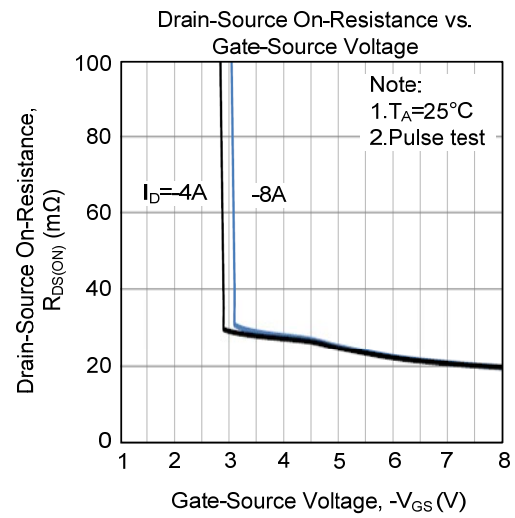
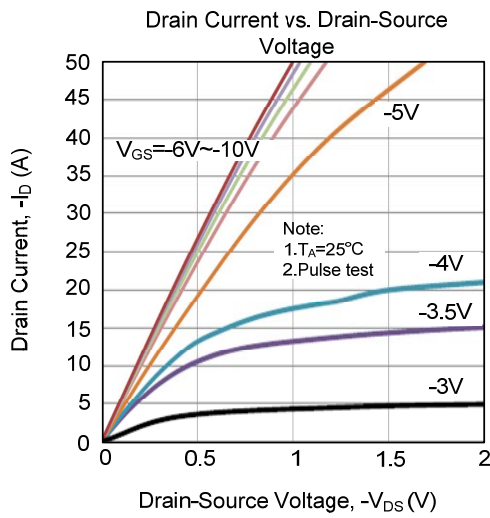


Unclamped Inductive Switching Test Circuit

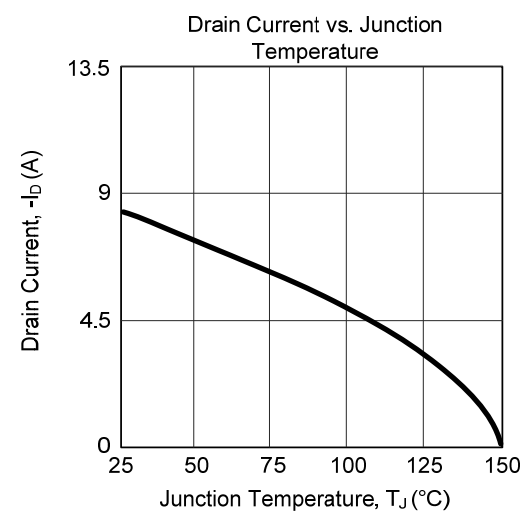
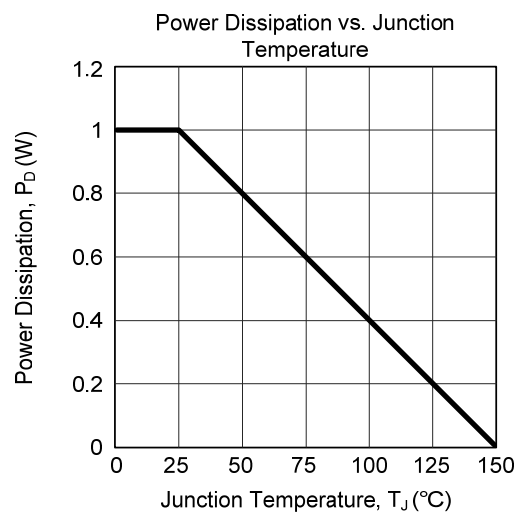
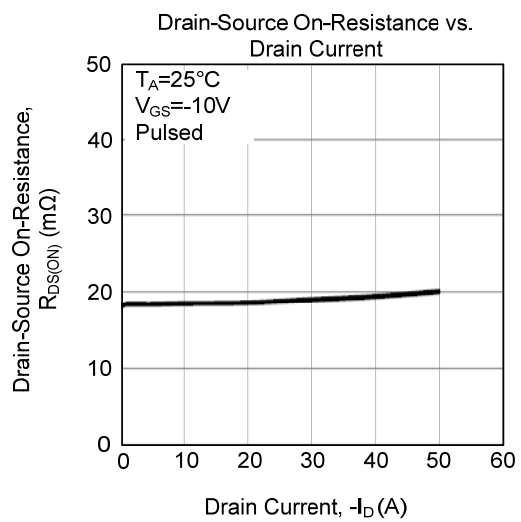
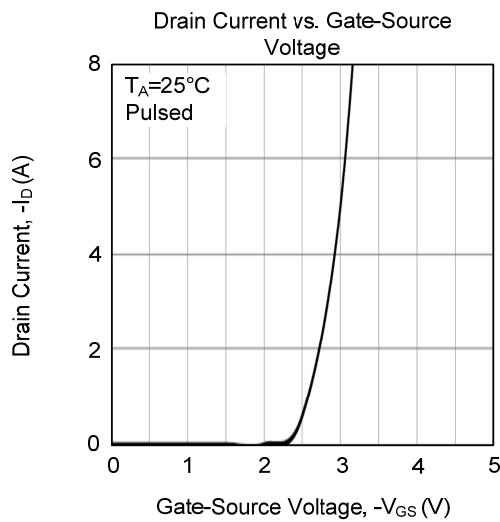
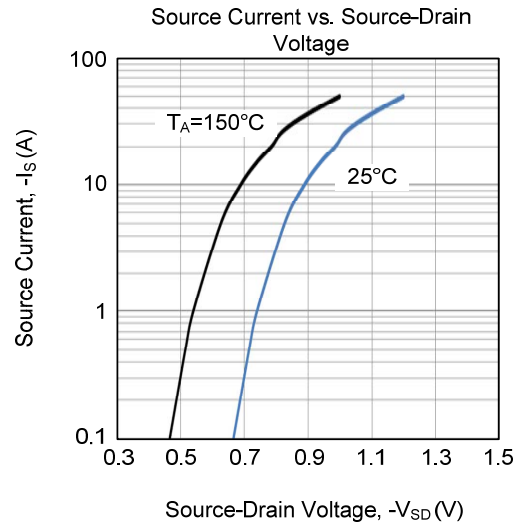
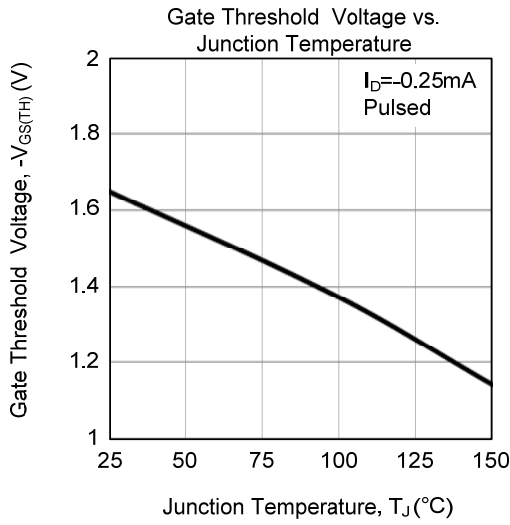


Unclamped Inductive Switching Waveforms

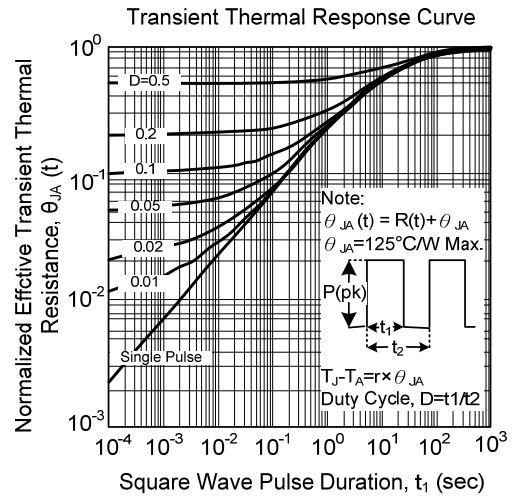
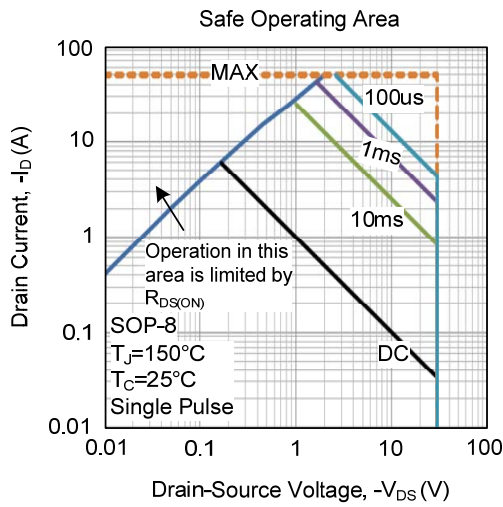
TYPICAL CHARACTERISTICS



■ TYPICAL CHARACTERISTICS (Cont.)



■ TYPICAL CHARACTERISTICS (Cont.)



Thermal characterization performed using the conditions described in Note 3b. Transient thermal response will change depending on the circuit board design.

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